

Product Summary

V_{RRM}	650 V
$I_F (T_c=160^\circ\text{C})$	6 A
Q_c	17 nC

Features

- Extremely low reverse current
- No reverse recovery current
- Temperature independent switching
- Positive temperature coefficient on V_F
- Excellent surge current capability
- Low capacitive charge

Benefits

- Essentially no switching losses
- System efficiency improvement over Si diodes
- Increased power density
- Enabling higher switching frequency
- Reduction of heat sink requirements
- System cost savings due to smaller magnetics
- Reduced EMI

Applications

- Switch mode power supplies (SMPS)
- Uninterruptible power supplies
- Motor drivers
- Power factor correction

Package Pin Definitions

- Pin1 and backside - Cathode
- Pin2 - Anode

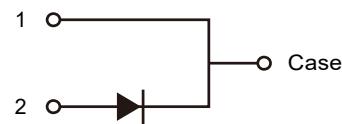
Package Parameters

Part Number	Marking	Package
B2D06065K	B2D06065K	TO-220-2

Package: TO-220-2



Electrical Connection



Maximum Ratings ($T_c=25^\circ\text{C}$ unless otherwise specified)

Symbol	Parameter	Test conditions	Value	Unit
V_{RRM}	Repetitive peak reverse voltage		650	V
V_{RSM}	Non-repetitive peak reverse voltage		650	V
I_F	Continuous forward current	$T_c=25^\circ\text{C}$ $T_c=160^\circ\text{C}$	26 6	A
I_{FSM}	Non-repetitive forward surge current	$T_c=25^\circ\text{C}, t_p=10\text{ms}$ Half sine wave	48	A
$\int i^2 dt$	i ² t value	$T_c=25^\circ\text{C}, t_p=10\text{ms}$	11.52	A ² S
P_{tot}	Power dissipation	$T_c=25^\circ\text{C}$ $T_c=110^\circ\text{C}$	119 51	W
T_j	Operating junction temperature		-55~175	°C
T_{stg}	Storage temperature		-55~175	°C
	TO-220 mounting torque	M3 Screw	0.7	Nm

Thermal Characteristics

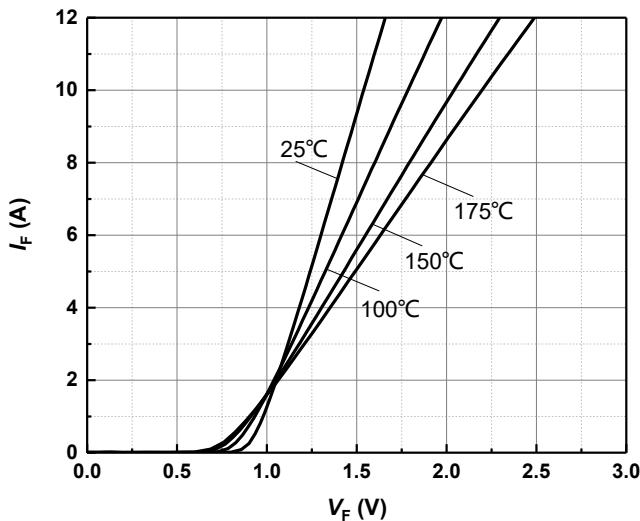
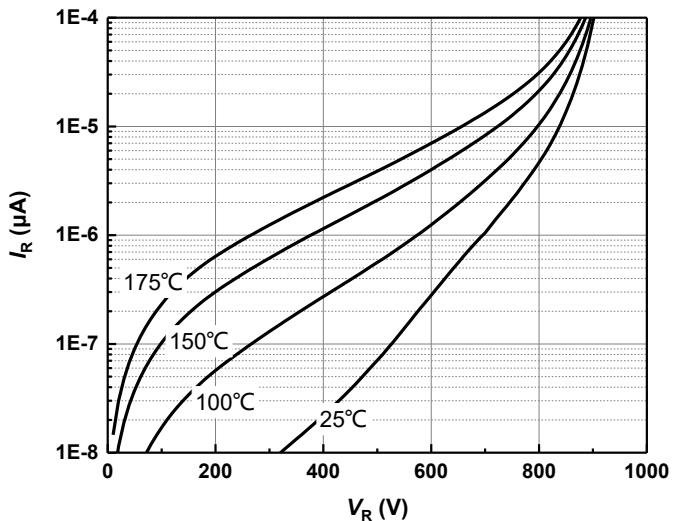
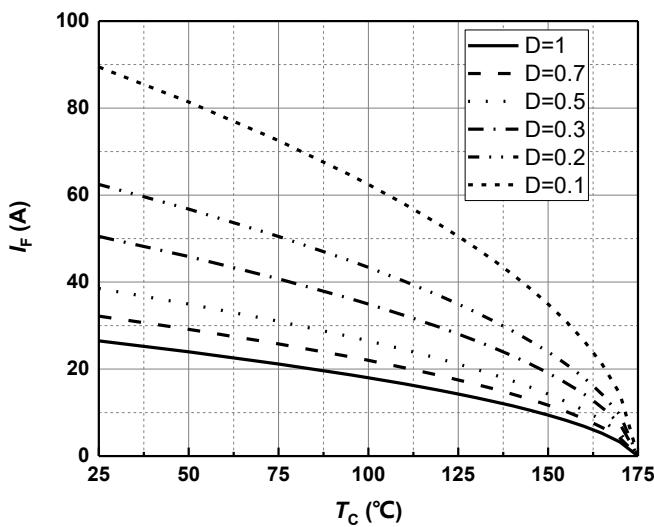
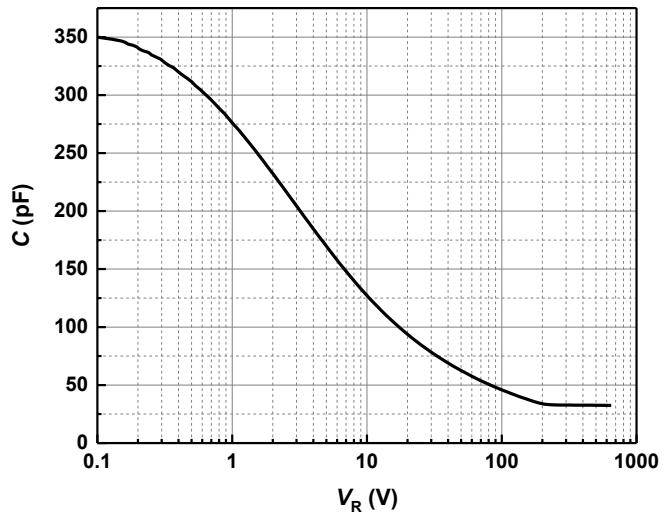
Symbol	Parameter	Value			Unit
		Min.	Typ.	Max.	
$R_{th(jc)}$	Thermal resistance from junction to case		1.254		K/W

Electrical Characteristics
Static Characteristics

Symbol	Parameter	Test conditions	Value			Unit
			Min.	Typ.	Max.	
V_{DC}	DC blocking voltage	$T_j=25^\circ C$	650			V
V_F	Diode forward voltage	$I_F=6A T_j=25^\circ C$ $I_F=6A T_j=175^\circ C$		1.33 1.63		V
I_R	Reverse current	$V_R=650V T_j=25^\circ C$ $V_R=650V T_j=175^\circ C$		1 15		μA

AC Characteristics

Symbol	Parameter	Test conditions	Value			Unit
			Min.	Typ.	Max.	
Q_C	Total capacitive charge	$V_R=400V T_j=25^\circ C$ $Q_C=\int_0^{V_R} C(V)dV$		17		nC
C	Total capacitance	$V_R=1V f=1MHz$ $V_R=300V f=1MHz$ $V_R=600V f=1MHz$		271 30.1 29.8		pF
E_C	Capacitance stored energy	$V_R=400V$		4.5		μJ

Typical Performance

Figure 1 Typical forward characteristics

Figure 2 Typical reverse current as function of reverse voltage

Figure 3 Diode forward current as function of temperature, D=duty cycle

Figure 4 Typical capacitance as function of reverse voltage, $C=f(V_R)$; $T_j=25^\circ\text{C}$; $f=1 \text{ MHz}$

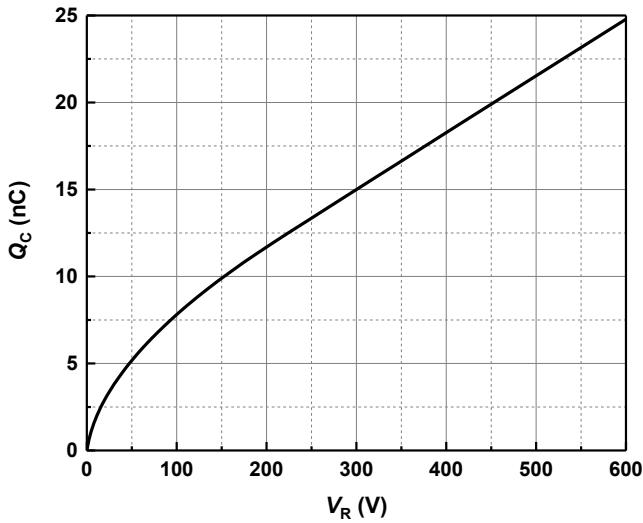
Typical Performance


Figure 5 **Typical reverse charge as function of reverse voltage**

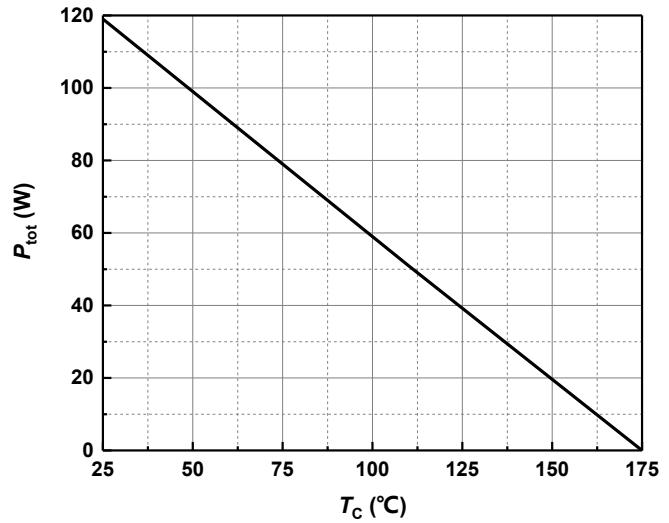


Figure 6 **Power dissipation as function of case temperature**

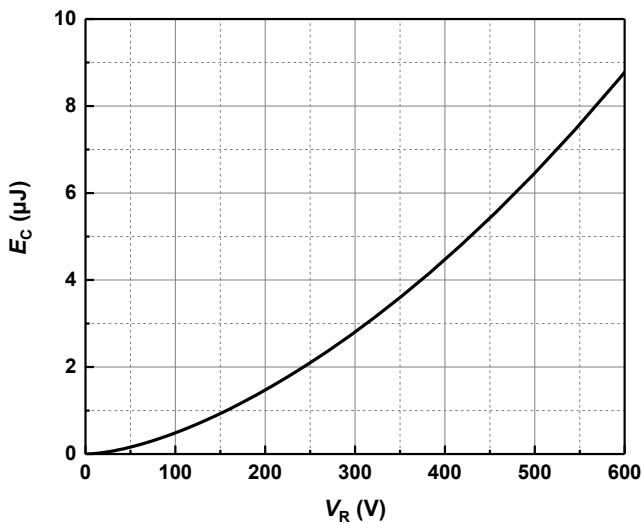


Figure 7 **Capacitance stored energy**

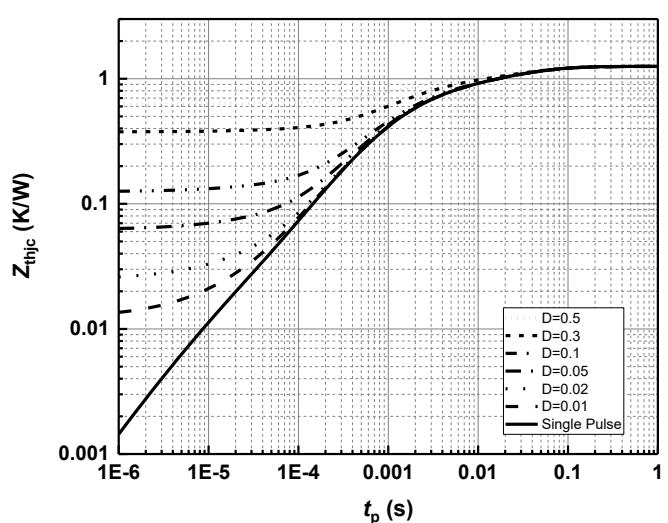
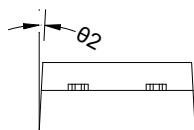
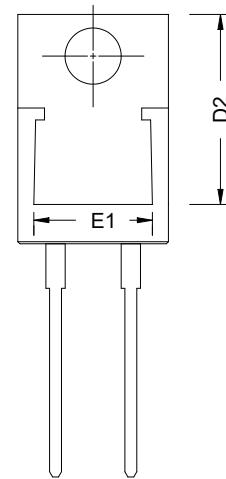
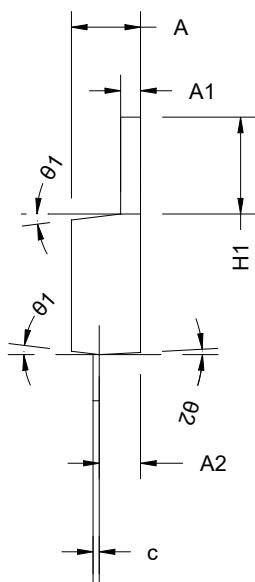
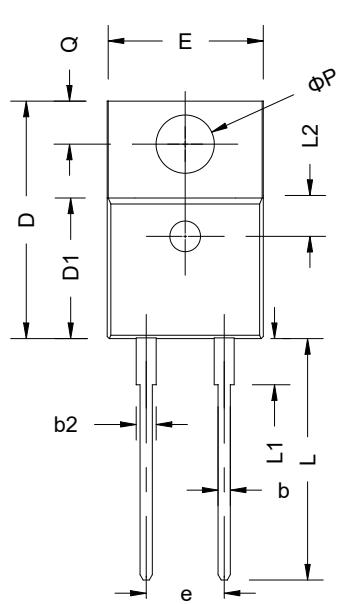


Figure 8 **Max. transient thermal impedance, $Z_{thjc} = f(t_p)$, parameter: $D = t_p / T$**



Package Dimensions



SYMBOL	mm		
	MIN	NOM	MAX
A	4.37	4.57	4.77
A1	1.22	-	1.40
A2	2.49	2.69	2.89
b	0.75	-	0.96
b2	1.22	-	1.47
c	0.30	-	0.48
D	15.15	15.45	15.75
D1	9.05	9.15	9.25
D2	11.40	-	12.88
E	9.86	10.16	10.36
E1	6.86	-	8.89
e	4.98	5.08	5.18
H1	6.10	6.30	6.50
L	12.70	-	13.70
L1	-	-	4.10
L2	2.50 REF		
φ P	3.70	3.84	3.99
Q	2.54	-	2.94
θ1	5°	7°	9°
θ2	1°	3°	5°

Revision History

Document Version	Date of Release	Description of Changes
Rev. 0.0	2020-10-06	Release of the preliminary datasheet.
Rev. 0.1	2020-12-16	Characteristics updated.
Rev. 0.2	2021-01-20	Characteristics updated.
Rev. 0.3	2021-12-06	Updated.

BASiC Semiconductor Ltd.
Shenzhen, China
© 2021 BASiC Semiconductor Ltd.
All Rights Reserved.

Information

For further information on technology, delivery terms and conditions and prices, please contact the nearest BASiC Semiconductor Office

Disclaimer

The information given in this document shall in no event be regarded as a guarantee of conditions or characteristics. With respect to any examples or hints given herein, any typical values stated herein and/or any information regarding the application of the device, BASiC semiconductor Ltd. hereby disclaims any and all warranties and liabilities of any kind, including without limitation, warranties of non-infringement of intellectual property rights of any third party.